LITEON LITE-ON SEMICONDUCTORS

SBF1050CT thru 1060CT

ITO-220AB

MIN.

15.50

10.0

3.00

9.00

2.90

13.46

1.15

2.40

0.75

0.45

4.36

2.48

2.50

3.00Ø

MAX

16.50

10.40

3.50

9.30

3.60

14.22

1.70

2.70

1.00

0.70

4.77

2.80

2.80

3.30 Ø

REVERSE VOLTAGE – 50 to 60 Volts

FORWARD CURRENT – 10 Amperes

SCHOTTKY BARRIER RECTIFIERS

FEATURES

- Metal of silicon rectifier, majority carrier conduction
- · Guard ring for transient protection
- · Low power loss, high efficiency
- High current capability, low VF
- · High surge capability
- Plastic package has UL flammability classification 94V-0
- · For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

MECHANICAL DATA

- Case: ITO-220AB molded plastic
- · Polarity: As marked on the body
- Weight: 0.06 ounces, 1.70 grams
- Mounting position: Any
- Max. mounting torque = 0.5 N.m (5.1 Kgf-cm)

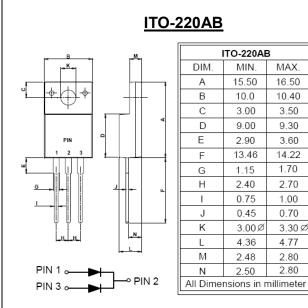
MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS Ratings at 25°C ambient temperature unless otherwise specified.

PARAMETER	SYMBOL	SBF1050CT	SBF1060CT	UNIT
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	50	60	V
Maximum RMS Voltage	V _{RMS}	35	42	V
Maximum DC Blocking Voltage	V _{DC}	50	60	V
Maximum Average Forward Rectified Current(See Fig.1) @TC=80°C	I _(AV)	10		A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	150		A
Maximum Forward Voltage at 5A DC (Note1)	VF	0.7		V
Maximum DC Reverse Current@TJ=25°Cat Rated DC Blocking Voltage@TJ=100°C	I _R	0.3 30		mA
Typical Junction Capacitance per element (Note 2)	CJ	250		РF
Typical thermal resistance _ Junction to Lead (Note 3)	R⊖ _{JL}	4.5		°C/W
Operating junction temperature range	TJ	-55 to +125		°C
Storage temperature range	T _{STG}	-55 to +150		°C
Dielectric Strength from terminals to case, AC with t=1 minute, RH<30%	V _{dis}	2000		v
Note :			REV. 5, Apr-2011, I	KTHC34

300us Pulse Width, 2% Duty Cycle ... (1)

Measured at 1.0MHz and applied reverse voltage of 4.0 V DC (2)

Thermal Resistance Junction to Lead with L42xH25xW25mm_black Aluminum finny heat sink.. (3)



RATING AND CHARACTERISTIC CURVES SBF1050CT thru SBF1060CT

FIG.1-FORWARD CURRENT DERATING CURVE FIG.2- MAXIMUM NON-REPETITIVE SURGE CURRENT 12 150 L42xH25xW25mm_black Aluminum finny heat sink,Rth j-c=6.5°C/W ₹ ₹ 10 PEAK FORWARD SURGE CURRENT, 125 AVERAGE FORWARD CURRENT, 8 Without heat sink, 100 Rth j-c=11°C/W 6 75 50 4 2 25 8.3ms Single Half Sine-Wave RESISTIVE OR INDUCTIVE LOAD 0 0 10 100 0 25 50 75 100 125 1 NUMBER OF CYCLES AT 60Hz CASE TEMPERATURE, (C) FIG.3- TYPICAL REVERSE CHARACTERISTICS FIG.4- TYPICAL FORWARD CHARACTERISTICS 100 100 10 INSTANTANEOUS REVERSE INSTANTANEOUS FORWARD Tj=100°C 10 CURRENT, (mA) CURRENT, (A) 1 0.1 Tj=25°C 1 Tj=25°C, PULSE WIDTH 300us, 0.01 2% Duty Cycle 0.001 0.1 40 60 80 100 120 140 0 20 0.1 0.2 0.3 0.4 0.5 0.6 0.7 0.8 0.9 1 PERCENT OF RATED PEAK REVERSE VOLTAGE, (V) INSTANTANEOUS FORWARD VOLTAGE, (V) FIG.5- TYPICAL JUNCTION CAPACITANCE FIG.6- DC REVERSE VOLTAGE DERATING CURVE 120 1000 L42xH25xW25mm_black Aluminum finny heat sink, Rth j-a : 13°C/W PERCENT OF DC REVERSE VOLTAGE (%) 07 09 08 00 08 ТП CAPACITANCE, (pF) 60 100 Ц Without heat sink, Rth j-a : 28°C/W Tj=25°C, f=1MHz 10 0 0.1 100 10 1 0 25 50 75 100 125 REVERSE VOLTAGE, (V) AMBIENT TEMPERATURE, (°C)



Important Notice and Disclaimer

LSC reserves the right to make changes to this document and its products and specifications at any time without notice. Customers should obtain and confirm the latest product information and specifications before final design, purchase or use.

LSC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does LSC assume any liability for application assistance or customer product design. LSC does not warrant or accept any liability with products which are purchased or used for any unintended or unauthorized application.

No license is granted by implication or otherwise under any intellectual property rights of LSC.

LSC products are not authorized for use as critical components in life support devices or systems without express written approval of LSC.